

ULTRA PRECISION DIFFERENTIAL CML 4:1 MUX WITH 1:2 FANOUT AND INTERNAL I/O TERMINATION

Precision Edge[®] SY58028U

FEATURES



Selects 1 of 4 differential inputs

- Provides two copies of the selected input
- Guaranteed AC performance over temperature and voltage:
 - DC-to- > 10.7Gbps data rate throughput
 - < 350ps IN-to-Out t_{pd}
 - < 60ps t_r / t_f times
- Ultra low-jitter design:
 - <10ps_{PP} total jitter (clock)
 - < 1ps_{RMS} random jitter
 - < 10ps_{PP} deterministic jitter
 - < 0.7ps_{RMS} crosstalk-induced jitter
- Unique patended input design minimizes crosstalk
- Accepts an input signal as low as 100mV
- Unique patended input termination and V_T pin accepts DC- and AC-coupled inputs (CML, LVPECL, LVDS)
- Internal 50 output source termination
- 400mV CML output swing ($R_L = 50\Omega$)
- Power supply 2.5V ±5% or 3.3V ±10%
- -40°C to +85°C temperature range
- Available in 32-pin (5mm × 5mm) MLF[®] package

APPLICATIONS

- Redundant clock and/or data distribution
- All SONET/SDH clock/data distribution
- Loopback
- All Fibre Channel distribution
- All Gigabit Ethernet clock and/or data distribution

TYPICAL PERFORMANCE



TIME (100ps/div.)

Precision Edge is a registered trademark of Micrel, Inc. *Micro*LeadFrame and MLF are registered trademarks of Amkor Technology, Inc. Precision Edge®

DESCRIPTION

The SY58028U is a 2.5V/3.3V precision, high-speed, 4:1 differential CML multiplexer capable of handling clocks up to 7GHz and data streams up to 10.7Gbps. In addition, a 1:2 fanout buffer provides two copies of the selected inputs.

The differential input includes Micrel's unique, 3-pin input termination architecture that allows customers to interface to any differential signal (AC- or DC-coupled) as small as 100mV without any level shifting or termination resistor networks in the signal path. The result is a clean, stub-free, low-jitter interface solution. The outputs are 50Ω source terminated CML, with extremely fast rise/fall times guaranteed to be less than 60ps.

The SY58028U operates from a 2.5V \pm 5% supply or a 3.3V \pm 10% supply and is guaranteed over the full industrial temperature range of -40°C to +85°C. For applications that require LVPECL outputs, consider the SY58029U or SY58030U Multiplexers. The SY58028U is part of Micrel's high-speed, Precision Edge[®] product line.

All support documentation can be found on Micrel's web site at www.micrel.com.

FUNCTIONAL BLOCK DIAGRAM



PACKAGE/ORDERING INFORMATION



Ordering Information⁽¹⁾

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY58028UMI	MLF-32	Industrial	SY58028U	Sn-Pb
SY58028UMITR ⁽²⁾	MLF-32	Industrial	SY58028U	Sn-Pb
SY58028UMG ⁽³⁾	MLF-32	Industrial	SY58028U with Pb-Free bar-line indicator	Pb-Free NiPdAu
SY58028UMGTR ^(2, 3)	MLF-32	Industrial	SY58028Uwith Pb-Free bar-line indicator	Pb-Free NiPdAu

Notes:

1. Contact factory for die availability. Dice are guaranteed at $T_A = 25^{\circ}C$, DC electricals only.

2. Tape and Reel.

3. Pb-Free package recommended for new designs.

PIN DESCRIPTION

Pin Number	Pin Name	Pin Function	
1, 4 5, 8 25, 28 29, 32	IN0, /IN0 IN1, /IN1 IN2, /IN2 IN3, /IN3	Differential Inputs: These inputs accept AC- or DC-coupled signals as small as 100mV. Each pin of a pair internally terminates to a V _T pin through 50 Ω . Note that these inputs will default to an indeterminate state if left open. If an input pair is not used, connect one input of the pair to ground through a 1k Ω resistor and the complement to V _{CC} through a 825 Ω resistor. Unused V _T and V _{REF-AC} may also be left open. Please refer to the "Input Interface Applications" section for more details.	
2, 6, 26, 30	VT0, VT1 VT2, VT3	Input Termination Center-Tap: Each side of the differential input pair terminates to a V_T pin. The V_T pin provides a center-tap to the termination network for maximum interface flexibility. See "Input Interface Applications" section for more details.	
15, 18	SEL0, SEL1	This single-ended TTL/CMOS compatible input selects the inputs to the multiplexer. Note that this input is internally connected to a $25k\Omega$ pull-up resistor and will default to a logic HIGH state if left open. Input logic threshold is V _{CC} /2. See "Truth Table" for select control.	
14, 19	NC	No Connect.	
10, 13, 16 17, 20, 23	VCC	Positive Power Supply: Bypass with $0.1\mu F 0.01\mu F$ low ESR capacitors.	
11, 12 21, 22	/Q0, Q0 /Q1, Q1	Differential Outputs: These CML output pairs are copies of the selected input. Unused output pairs may be left floating. See "Output Interface" section for termination guidelines.	
9, 24	GND, Exposed Pad	Ground. Ground pin and exposed pad must be connected to the same ground plane.	
3, 7, 27, 31	VREF-AC0 VREF-AC1 VREF-AC2 VREF-AC3	Reference Voltage: This reference output is equivalent to V _{CC} -1.4V. It is used for AC-coupled inputs. When interfacing to AC input signals, connect V _{REF-AC} directly to the V _T pin and bypass with 0.01 μ F low ESR capacitor to V _{CC} . See "Input Interface Applications" section. Maximum sink/source current is 0.5mA.	

TRUTH TABLE

SEL1	SEL0	
0	0	IN0 Input Selected
0	1	IN1 Input Selected
1	0	IN2 Input Selected
1	1	IN3 Input Selected

Power Supply Voltage (V _{CC})	–0.5V to +4.0V
Input Voltage (V _{IN})	–0.5V to V _{CC}
CML Output Voltage (V _{OUT})	V_{CC} -1.0V to V_{CC} +0.5V
Termination Current ⁽³⁾	
Source or sink current on V_T pin	±100mA
Input Current	
Source or sink current on IN, /IN	pin±50mA
Lead Terrer eneture (addering 00 er	

Operating Ratings⁽²⁾

Power Supply Voltage (V _{CC})	
Ambient Temperature Range (T _A)	40°C to +85°C
Package Thermal Resistance ⁽⁴⁾	
MLF [®] (θ _{JA})	
Still-Air	35°C/W
MLF [®] (ψ _{JB})	
Junction-to-Board	2°C/W

DC ELECTRICAL CHARACTERISTICS⁽⁵⁾

 $T_A = -40^{\circ}C$ to 85°C, unless otherwise stated.

Symbol	Parameter	Condition	Min	Тур	Мах	Units
V _{CC}	Power Supply Voltage	$V_{CC} = 2.5V$ $V_{CC} = 3.3V$	2.375 3.0	2.5 3.3	2.625 3.6	V V
I _{CC}	Power Supply Current	No load, max. V _{CC}		120	150	mA
R _{DIFF_IN}	Differential Input Resistance (IN-to-/IN)		80	100	120	Ω
R _{IN}	Input Resistance (IN-to-V _T , /IN-to-V _T)		40	50	60	Ω
V _{IH}	Input HIGH Voltage (IN-to-/IN)	Note 6	V _{CC} -1.6		V _{CC}	V
V _{IL}	Input LOW Voltage (IN-to-/IN)		0		V _{IH} –0.1	V
V _{IN}	Input Voltage Swing (IN-to-/IN)	See Figure 1a.	0.1		1.7	V
V _{DIFF_IN}	Differential Input Voltage Swing (IN-to-/IN)	See Figure 1b.	0.2			V
V _T IN	Max Input Voltage (IN-to-V _T)				1.28	V
V _{REF-AC}	Reference Voltage		V _{CC} -1.3	V _{CC} -1.2	V _{CC} -1.1	V

Notes:

1. Permanent device damage may occur if ratings in the "Absolute Maximum Ratings" section are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.

2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.

3. Due to the limited drive capability, use for input of the same package only.

4. Thermal performance assumes exposed pad is soldered (or equivalent) to the device's most negative potential (GND) on the PCB. Ψ_{JB} uses 4-layer θ_{JA} in still air number unless otherwise stated.

5. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

6. V_{IH} (min) not lower than 1.2V.

CML OUTPUT DC ELECTRICAL CHARACTERISTICS⁽⁷⁾

 $V_{CC} = 2.5V \pm 5\%$ or $3.3V \pm 10\%$; $T_A = -40^{\circ}C$ to $85^{\circ}C$; $R_L = 100\Omega$ across each output pair or equivalent; unless otherwise stated.

Symbol	Parameter	Condition	Min	Тур	Мах	Units
V _{OH}	Output HIGH Voltage		V _{CC} -0.020		V _{CC}	V
V _{OUT}	Output Voltage Swing	See Figure 1a.	325	400		mV
V _{DIFF_OUT}	Differential Output Voltage Swing	See Figure 1b.	650	800		mV
R _{OUT}	Output Source Impedance		40	50	60	Ω

LVTTL/CMOS DC ELECTRICAL CHARACTERISTICS⁽⁷⁾

 V_{CC} = 2.5V ±5% or 3.3V ±10%; T_A = -40°C to +85°C, unless otherwise stated.

Symbol	Parameter	Condition	Min	Тур	Max	Units
V _{IH}	Input HIGH Voltage	SEL0, SEL1	2.0			V
V _{IL}	Input LOW Voltage	SEL0, SEL1			0.8	V
I _{IH}	Input HIGH Current				40	μΑ
IIL	Input LOW Current				-300	μΑ

Note:

7. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

AC ELECTRICAL CHARACTERISTICS⁽⁸⁾

V_{CC} = 2.5V ±5% or 3.3V ±10%; R_L = 100Ω across each output pair, or equivalent; T_A= -40°C to +85°C, V_{IN} ≥ 100mV unless otherwise stated.

Symbol	Parameter	Condition	Min	Тур	Мах	Units
f _{MAX}	Maximum Operating Frequency	NRZ Data	10.7			Gbps
		V _{OUT} ≥ 200mV Clock		7		GHz
t _{pd}	Propagation Delay (Diff) (IN to Q)	$V_{IN} \ge 100 mV$	170	260	340	ps
	(SEL to Q)		100		500	ps
t _{pd} Tempco	Differential Propagation Delay Temperature Coefficient			115		fs/°C
t _{SKEW}	Output-to-Output	Note 9		7	20	ps
	Part-to-Part	Note 10			50	ps
t _{JITTER}	Data Random Jitter	Note 11 2.5Gbps to 3.2Gbps			1	ps _{RMS}
	Deterministic Jitter	Note 12 2.5Gbps to 3.2Gbps			10	ps _{PP}
	Clock Cycle-to-Cycle Jitter	Note 13			1	ps _{RMS}
	Total Jitter	Note 14			10	ps _{PP}
	Crosstalk Induced Jitter (Adjacent Channel)	Note 15			0.7	ps _{RMS}
t _r , t _f	Output Rise/Fall Time	20% to 80%, Full output swing	20	45	60	ps

Notes:

8. High frequency AC electricals are guaranteed by design and characterization.

9. Output-to-output skew is measured between outputs under identical input conditions.

10. Part-to-part skew is defined for two parts with identical power supply voltages at the same temperature and with no skew of the edges at the respective inputs.

- 11. Random jitter is measured with a K28.7 comma detect character pattern, measured at 2.5Gbps to 3.2Gbps.
- 12. Deterministic jitter is measured at 2.5Gbps to 3.2Gbps, with both K28.5 and 2²³-1 PRBS pattern.
- 13. Cycle-to-cycle jitter definition: the variation of periods between adjacent cycles, T_n-T_{n-1} where T is the time between rising edges of the output signal.
- Total jitter definition: with an ideal clock input of frequency ≤ f_{MAX}, no more than one output edge in 10¹² output edges will deviate by more than the specified peak-to-peak jitter value.
- 15. Crosstalk is measured at the output while applying two similar clock frequencies that are asynchronous with respect to each other at the inputs.

SINGLE-ENDED AND DIFFERENTIAL SWINGS





Figure 1a. Single-Ended Voltage Swing

Figure 1b. Differential Voltage Swing

TIMING DIAGRAMS



Figure 2a. IN-to-Q Timing Diagram



Figure 2b. SEL-to-Q Timing Diagram

SEL0 Q:	or:	SEL1 = LOW; SEL1 = HIGH;	IN0, /IN1 = LOW; IN2, /IN3 = LOW;	/IN0, IN1 = HIGH /IN2, IN3 = HIGH
SEL1 Q:	or:	SEL0 = LOW; SEL0 = HIGH;	IN0, /IN2 = LOW; IN1, /IN3 = LOW;	/IN0, IN2 = HIGH /IN1, IN3 = HIGH

FUNCTIONAL CHARACTERISTICS

 V_{CC} = 2.5V, GND = 0, V_{IN} = 100mV, T_A = 25°C, unless otherwise stated.





TIME (25ps/div.)

TYPICAL OPERATING CHARACTERISTICS

 V_{CC} = 2.5V, GND = 0, V_{IN} = 100mV, T_A = 25°C, unless otherwise stated.







INPUT STAGE





INPUT INTERFACE APPLICATIONS



Figure 4a. DC-Coupled CML Interface Option: May connect V_T to V_{CC}



Figure 4d. AC-Coupled LVPECL Interface



Figure 4b. CML Interface (AC-Coupled)

 $V_{\rm CC}$

Q

LVDS

 \triangleleft



Figure 4c. DC-Coupled PECL Interface



IN

/IN

SY58028U

Interface

OUTPUT INTERFACE APPLICATIONS









RELATED MICREL PRODUCTS AND SUPPORT DOCUMENTATION

Part Number	Function	Data Sheet Link
SY58028U	Ultra Precision Differential CML 4:1 MUX with 1:2 Fanout and Internal I/O Termination	http://www.micrel.com/product-info/products/sy58028u.shtml
SY58029U	Ultra Precision Differential LVPECL 4:1 MUX with 1:2 Fanout and Internal Termination	http://www.micrel.com/product-info/products/sy58029u.shtml
SY58030U	Ultra Precision, 400mV Differential LVPECL 4:1 MUX with 1:2 Fanout and Internal Termination	http://www.micrel.com/product-info/products/sy58030u.shtml
	MLF [®] Application Note	www.amkor.com/products/notes_papers/MLF_AppNote_0902.pdf
HBW Solutions	New Products and Applications	www.micrel.com/product-info/products/solutions.shtml

32-PIN*Micro*LeadFrame[®] (MLF-32)



PCB Thermal Consideration for 32-Pin MLF[®] Package (Always solder, or equivalent, the exposed pad to the PCB)

Package Notes:

- 1. Package meets Level 2 qualification.
- 2. All parts dry-packaged before shipment.
- 3. Exposed pads must be soldered to a ground for proper thermal management.

MICREL, INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131 USA

TEL + 1 (408) 944-0800 FAX + 1 (408) 474-100 WEB http://www.micrel.com

The information furnished by Micrel in this data sheet is believed to be accurate and reliable. However, no responsibility is assumed by Micrel for its use. Micrel reserves the right to change circuitry and specifications at any time without notification to the customer.

Micrel Products are not designed or authorized for use as components in life support appliances, devices or systems where malfunction of a product can reasonably be expected to result in personal injury. Life support devices or systems are devices or systems that (a) are intended for surgical implant into the body or (b) support or sustain life, and whose failure to perform can be reasonably expected to result in a significant injury to the user. A Purchaser's use or sale of Micrel Products for use in life support appliances, devices or systems is at Purchaser's own risk and Purchaser agrees to fully indemnify Micrel for any damages resulting from such use or sale.

© 2005 Micrel, Incorporated.